



# Product Change Notification

**Change Notification #:** 118444-00  
**Change Title:** Select Intel® Dual Band Wireless-AC 3100 Series,  
PCN 118444-00, Label,  
Label Update  
**Date of Publication:** August 20, 2021

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	September 11, 2021
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## Description of Change to the Customer:

The Intel® Dual Band Wireless-AC3100 Series SKUs listed in the products affected table below will undergo the following changes.

- 1) Add UKCA logo on both product and disti label.
- 2) The Intel tracking revision will be changed on the following product.

Product Code	Before	After
3165.D2WG	0H	0I

- 3) Product TA# dash up.

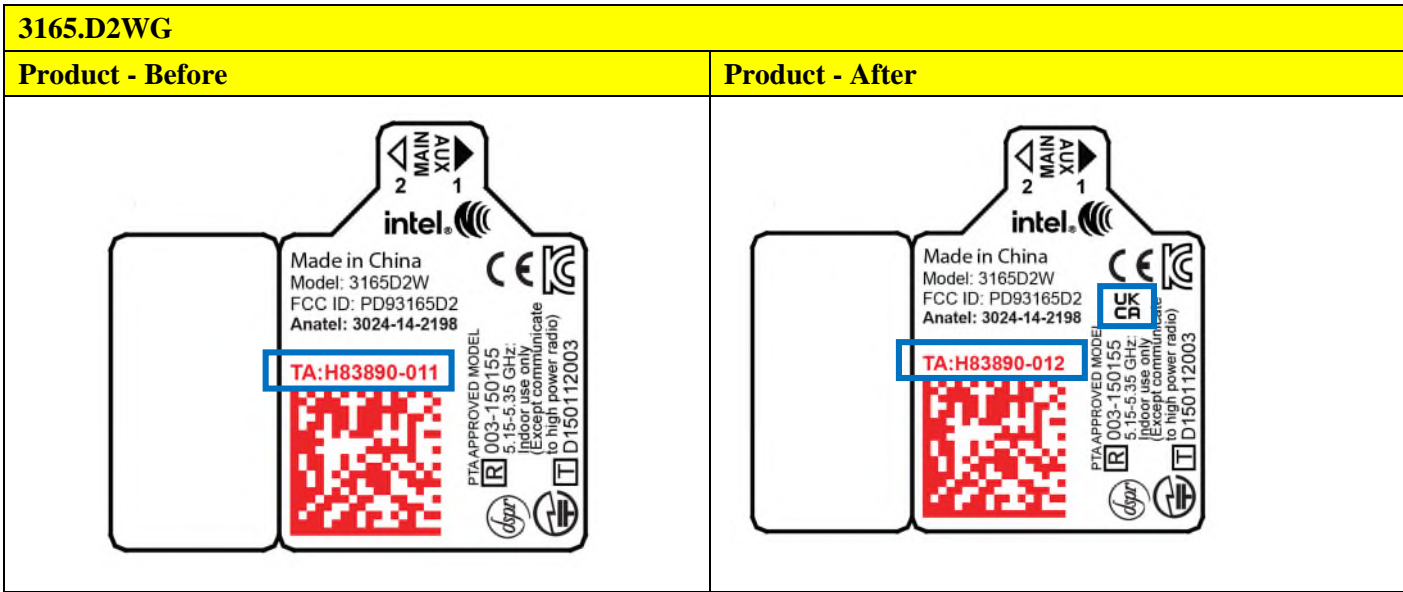
## Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes



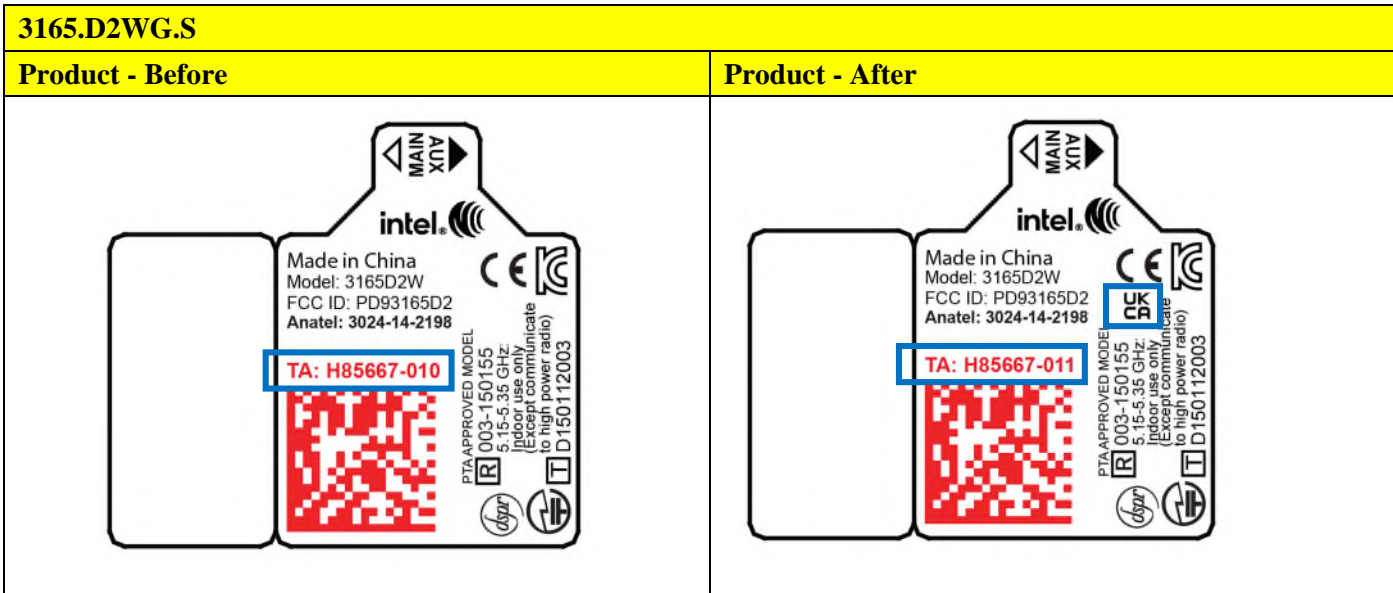
3165.D2WG

Disti - Before

<p><b>3165.D2WG</b></p> <p>VERSION # <b>H83890-011</b></p> <p>MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXX</b></p>	<p>QTY: <b>1000</b></p> <p>MM #: <b>XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD###PPPPPP100</b></p> <p>T P/N: <b>GTTTTTTTTTT</b></p> <p>D P/N: <b>PPPPPP</b> REV <b>AXX</b> HP P/N: <b>843530-001</b> REV: <b>0H</b></p> <p>Vendor ID   Loc Id   Mfg Id   L P/N: <b>XXXXXXXXXX</b> VVVVVLLLLL   MMMMM   EC: <b>XXXXXX</b></p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Compliant with IEC60950-1 ET7682</p> <p>CCAH15LP132079</p> <p>CMIT ID: 2015AJ3486 (M)</p> <p>CNC ID: C-16041 CNC ID: C-16002 CNC ID: C-16065 CNC ID: C-16005</p> <p>MSIP-CRM-INT-7265D2W</p>
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Disti - After

<p><b>3165.D2WG</b></p> <p>VERSION # <b>H83890-012</b></p> <p>MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXX</b></p>	<p>QTY: <b>1000</b></p> <p>MM #: <b>XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD###PPPPPP100</b></p> <p>T P/N: <b>GTTTTTTTTTT</b></p> <p>D P/N: <b>PPPPPP</b> REV <b>AXX</b> HP P/N: <b>843530-001</b> REV: <b>0I</b></p> <p>Vendor ID   Loc Id   Mfg Id   L P/N: <b>XXXXXXXXXX</b> VVVVVLLLLL   MMMMM   EC: <b>XXXXXX</b></p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Compliant with IEC60950-1 ET7682</p> <p>CCAH15LP132079</p> <p>CMIT ID: 2015AJ3486 (M)</p> <p>CNC ID: C-16041 CNC ID: C-16002 CNC ID: C-16065 CNC ID: C-16005</p> <p>MSIP-CRM-INT-7265D2W</p>
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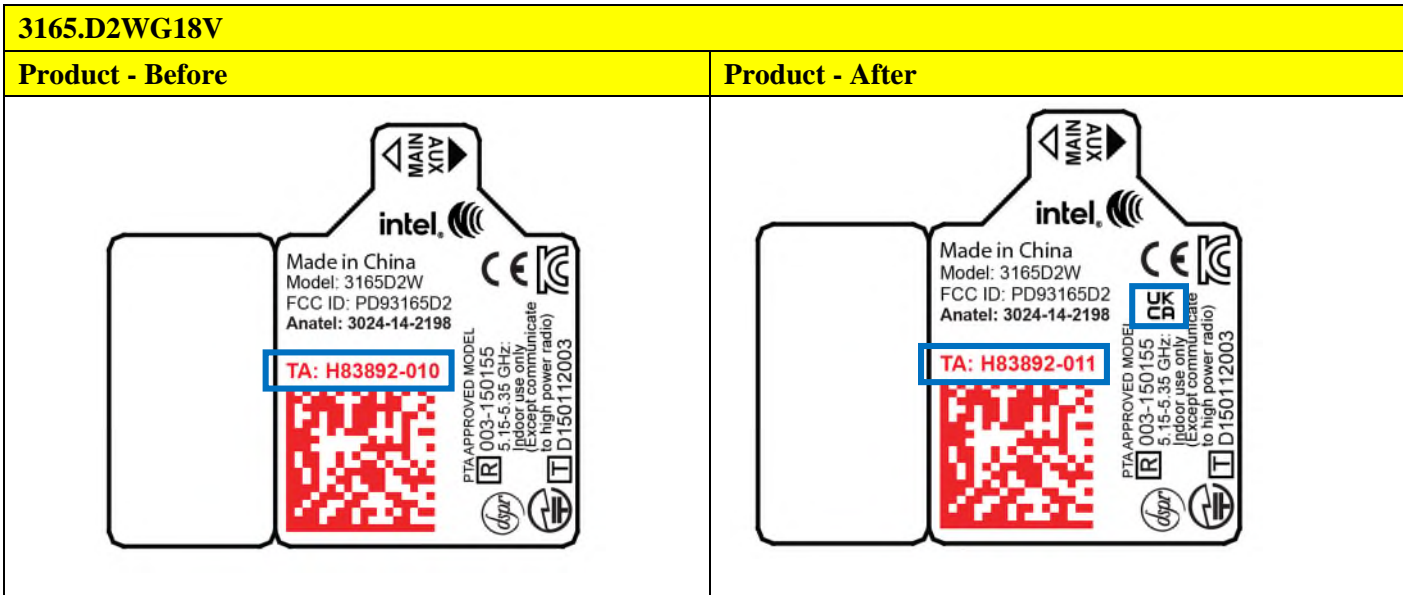
**3165.D2WG.S**

**Disti - Before**

<p><b>3165.D2WG.S</b></p> <p>VERSION #: <b>H85667-010</b></p> <p>MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXXXXX</b></p>	<p><b>QTY: 1000</b></p> <p>MM #: <b>XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD####PPPPP100</b></p> <p>T P/N: <b>GDM48000218</b></p> <p>D P/N: <b>PPPPPP</b> REV <b>AXX</b> HP P/N: <b>XXXXXX-XXX</b> REV: <b>XX</b></p> <p>Vendor ID   Loc Id   Mfg Id <b>VVVVVLLLLL</b>   <b>MMMMM</b></p> <p>L P/N: <b>XXXXXXXXXX</b> EC: <b>XXXXXXXXX</b></p>	<p>CE, UK, CB, UK CA</p> <p>Complies with IEC60950-1 E7882 CCAH15LP132079</p> <p>CNC</p> <p>CNC ID: C-16041 CNC ID: C-16002 CNC ID: C-16065 CNC ID: C-16005</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CMIIT ID: 2015AJ3466 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>
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**Disti - After**

<p><b>3165.D2WG.S</b></p> <p>VERSION #: <b>H85667-011</b></p> <p>MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXXXXX</b></p>	<p><b>QTY: 1000</b></p> <p>MM #: <b>XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD####PPPPP100</b></p> <p>T P/N: <b>GDM48000218</b></p> <p>D P/N: <b>PPPPPP</b> REV <b>AXX</b> HP P/N: <b>XXXXXX-XXX</b> REV: <b>XX</b></p> <p>Vendor ID   Loc Id   Mfg Id <b>VVVVVLLLLL</b>   <b>MMMMM</b></p> <p>L P/N: <b>XXXXXXXXXX</b> EC: <b>XXXXXXXXX</b></p>	<p>CE, UK, CB, UK CA</p> <p>Complies with IEC60950-1 E7882 CCAH15LP132079</p> <p>CNC</p> <p>CNC ID: C-16041 CNC ID: C-16002 CNC ID: C-16065 CNC ID: C-16005</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CMIIT ID: 2015AJ3466 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>
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**3165.D2WG18V**

**Disti - Before**

<p><b>3165.D2WG18V</b></p> <p>VERSION # <b>H83892-010</b></p> <p>MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXX</b></p>	<p>QTY: 1000</p> <p>MM #: <b>XXXXXX</b></p> <p>PACK DATE: DD MMM YY PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) VVVVVMMMMDDDD####PPPPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: P P P P P    REV AX X    HP P/N: XXXXXX-XXX    REV: XX</p> <p>Vendor ID   Loc Id    Mfg Id    L P/N: XXXXXXXXXXXX</p> <p>VVVVVLLLLL    M M M M M    EC: XXXXXXXX</p>	<p>CE, UKCA, FCC, PTA APPROVED MODELS</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CMIT ID: 2015AJ3469 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>
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**Disti - After**

<p><b>3165.D2WG18V</b></p> <p>VERSION # <b>H83892-011</b></p> <p>MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXX</b></p>	<p>QTY: 1000</p> <p>MM #: <b>XXXXXX</b></p> <p>PACK DATE: DD MMM YY PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) VVVVVMMMMDDDD####PPPPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: P P P P P    REV AX X    HP P/N: XXXXXX-XXX    REV: XX</p> <p>Vendor ID   Loc Id    Mfg Id    L P/N: XXXXXXXXXXXX</p> <p>VVVVVLLLLL    M M M M M    EC: XXXXXXXX</p>	<p>CE, UKCA, FCC, PTA APPROVED MODELS</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CMIT ID: 2015AJ3469 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>
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### Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Dual Band Wireless-AC 3165, 1x1 AC + BT, No vPro® M.2	3165.D2WG	944381	H83890-011	H83890-012
Intel® Dual Band Wireless-AC 3165, 1x1 AC + BT, No vPro® M.2, 1.8v	3165.D2WG18V	944382	H85667-010	H85667-011
Intel® Dual Band Wireless-AC 3165, 1x1 AC + BT, No vPro® M.2, Low Power	3165.D2WG.S	944397	H83892-010	H83892-011

### PCN Revision History:

**Date of Revision:**

August 20, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 118444-00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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